

Improved Precision Micropower Shunt Voltage Reference

ABSOLUTE MAXIMUM RATINGS

Reverse Current (cathode to anode)20mA
 Forward Current (anode to cathode)10mA
 Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)
 3-Pin SC70 (derate 2.17mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$).....174mW
 3-Pin SOT23 (derate 4.01mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$).....320mW

Operating Temperature Range
 LM4041_I_ _ _ -40°C to $+85^\circ\text{C}$
 LM4041_E_ _ _ -40°C to $+125^\circ\text{C}$
 Storage Temperature Range -65°C to $+150^\circ\text{C}$
 Junction Temperature $+150^\circ\text{C}$
 Lead Temperature (soldering, 10s) $+300^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($I_R = 100\mu\text{A}$, $T_A = T_{\text{MIN}}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Reverse Breakdown Voltage	V _R	T _A = +25°C	LM4041A (0.1%)	1.2238	1.2250	1.2262	V
			LM4041B (0.2%)	1.2226	1.2250	1.2275	
			LM4041C (0.5%)	1.2189	1.2250	1.2311	
			LM4041D (1.0%)	1.2128	1.2250	1.2373	
Reverse Breakdown Voltage Tolerance (Note 2)	ΔV _R		LM4041A (0.1%)	±1.2		±9.2	mV
			LM4041B (0.2%)	±2.4		±10.4	
			LM4041C (0.5%)	±6.0		±14	
			LM4041D (1.0%)	±12		±24	
Minimum Operating Current	I _{RMIN}		LM4041A/B/C	45		60	μA
			LM4041D	45		65	
Average Reverse Voltage Temperature Coefficient (Notes 2 and 3)	ΔV _R /ΔT	I _R = 10mA		±20			ppm/°C
		I _R = 1mA	LM4041A/B/C	±15		±100	
			LM4041D	±15		±150	
		I _R = 100μA				±15	
Reverse Breakdown Voltage Change with Operating Current Change	ΔV _R /ΔI _R	I _{RMIN} ≤ I _R ≤ 1mA	LM4041A/B/C	0.7		1.5	mV
			LM4041D	0.7		2.0	
		1mA ≤ I _R ≤ 12mA	LM4041A/B/C	2.5		8.0	
			LM4041D	2.5		10.0	
Reverse Dynamic Impedance (Note 3)	Z _R	I _R = 1mA, f = 120Hz, I _{AC} = 0.1I _R	LM4041A/B/C	0.5		1.5	Ω
			LM4041D	0.5		2.0	

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ELECTRICAL CHARACTERISTICS (continued)

($I_R = 100\mu A$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Wideband Noise	e_N	$I_R = 100\mu A$, $10Hz \leq f \leq 10kHz$		20		μV_{RMS}
Reverse Breakdown Voltage Long-Term Stability	ΔV_R	$T = 1000h$, $I_R = 100\mu A$		120		ppm

Note 1: All devices are 100% production tested at $+25^\circ C$ and are guaranteed by design for $T_A = T_{MIN}$ to T_{MAX} , as specified.

Note 2: The overtemperature limit for Reverse Breakdown Voltage Tolerance is defined as the room-temperature Reverse Breakdown Voltage Tolerance $\pm[(\Delta V_R / \Delta T)(\max \Delta T)(V_R)]$, where $\Delta V_R / \Delta T$ is the V_R temperature coefficient, $\max \Delta T$ is the maximum difference in temperature from the reference point of $+25^\circ C$ to T_{MIN} or T_{MAX} , and V_R is the reverse breakdown voltage. The total overtemperature tolerance for the different grades in the temperature range where $\max \Delta T = +65^\circ C$ is shown below:

A grade: $\pm 0.75\% = \pm 0.1\% \pm 100\text{ppm}/^\circ C \times 65^\circ C$

B grade: $\pm 0.85\% = \pm 0.2\% \pm 100\text{ppm}/^\circ C \times 65^\circ C$

C grade: $\pm 1.15\% = \pm 0.5\% \pm 100\text{ppm}/^\circ C \times 65^\circ C$

D grade: $\pm 1.98\% = \pm 1.0\% \pm 150\text{ppm}/^\circ C \times 65^\circ C$

The total overtemperature tolerance for the different grades in the extended temperature range where $\max \Delta T = +100^\circ C$ is shown below:

A grade: $\pm 1.1\% = \pm 0.1\% \pm 100\text{ppm}/^\circ C \times 100^\circ C$

B grade: $\pm 1.2\% = \pm 0.2\% \pm 100\text{ppm}/^\circ C \times 100^\circ C$

C grade: $\pm 1.5\% = \pm 0.5\% \pm 100\text{ppm}/^\circ C \times 100^\circ C$

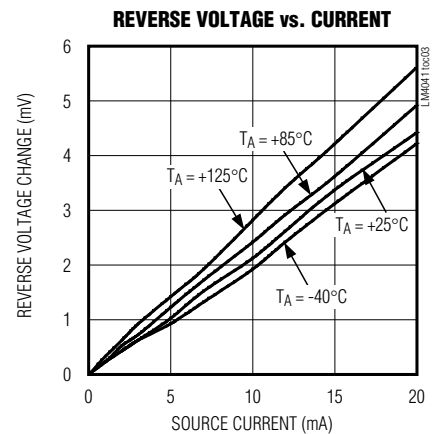
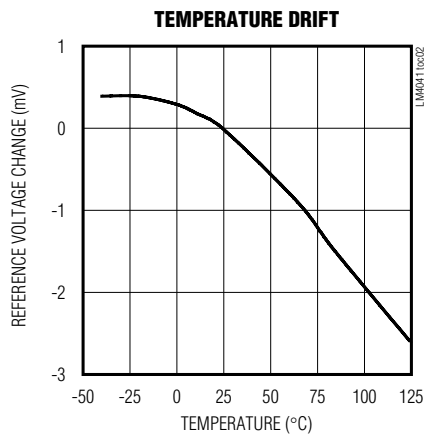
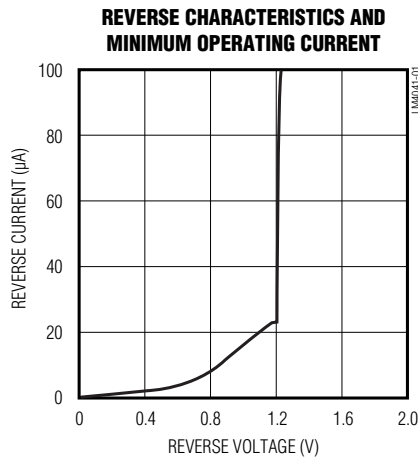
D grade: $\pm 2.5\% = \pm 1.0\% \pm 150\text{ppm}/^\circ C \times 100^\circ C$

Therefore, as an example, the A-grade LM4041-1.2 has an overtemperature reverse breakdown voltage tolerance of $\pm 2.5V \times 0.75\% = \pm 19mV$.

Note 3: Guaranteed by design.

Typical Operating Characteristics

($I_R = 100\mu A$, SC70-3 package, $T_A = +25^\circ C$, unless otherwise noted.)



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Typical Operating Characteristics (continued)

($I_R = 100\mu\text{A}$, SC70-3 package, $T_A = +25^\circ\text{C}$, unless otherwise noted.)

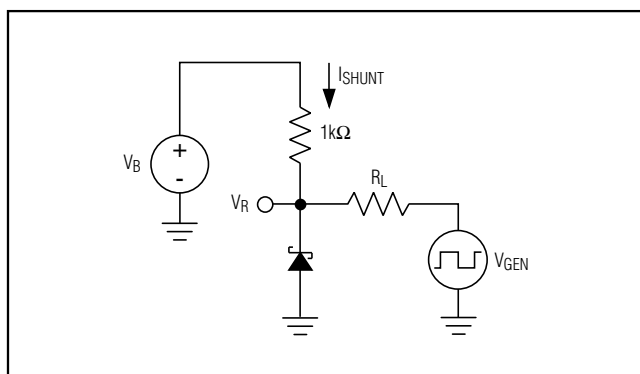
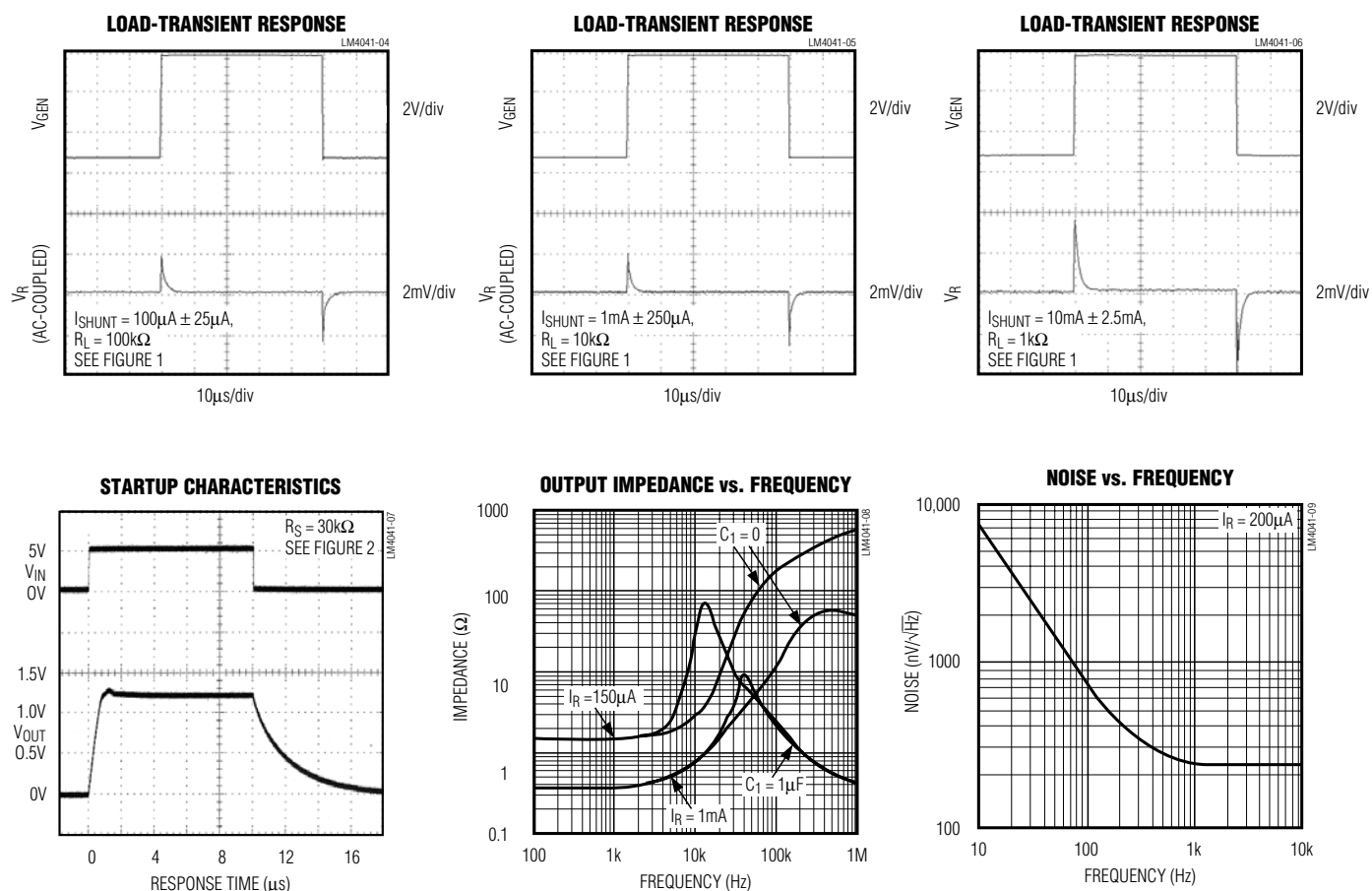


Figure 1. Load-Transient Test Circuit

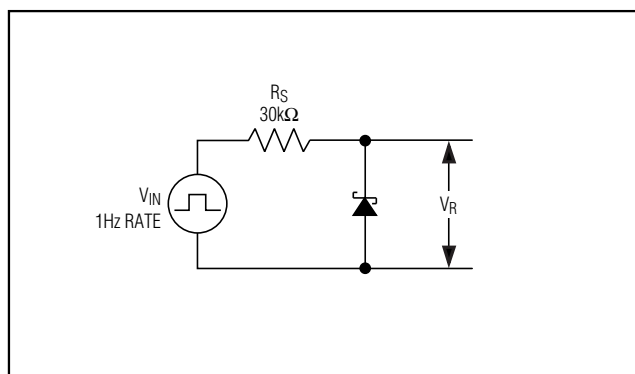


Figure 2. Startup Characteristics Test Circuit

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Pin Description

PIN	NAME	FUNCTION
1	+	Positive Terminal of the Shunt Reference
2	–	Negative Terminal of the Shunt Reference
3	N.C.	Leave this pin unconnected, or connect to pin 2.

Detailed Description

The LM4041 shunt references use the bandgap principle to produce a stable, accurate voltage. The device behaves similarly to an ideal zener diode; a fixed voltage of +1.225V is maintained across its output terminals when biased with 60μA to 12mA of reverse current. The LM4041 behaves similarly to a silicon diode when biased with forward currents up to 10mA.

Figure 3 shows a typical operating circuit. The LM4041 is ideal for providing a stable reference from a high-voltage power supply.

Applications Information

The LM4041's internal pass transistor is used to maintain a constant output voltage (V_{SHUNT}) by sinking the necessary amount of current across a source resistor. The source resistance (R_S) is determined from the load current (I_{LOAD}) range, supply voltage (V_S) variations, V_{SHUNT} , and desired quiescent current.

Choose the value of R_S when V_S is at a minimum and I_{LOAD} is at a maximum. Maintain a minimum I_{SHUNT} of 60μA at all times. The R_S value should be large enough to keep I_{SHUNT} less than 12mA for proper regulation when V_S is maximum and I_{LOAD} is at a minimum. To prevent damage to the device, I_{SHUNT} should never exceed 20mA.

Therefore, the value of R_S is bounded by the following equation:

$$\frac{[V_{S(MIN)} - V_R]}{[60\mu A + I_{LOAD(MAX)}]} > R_S > \frac{[V_{S(MAX)} - V_R]}{[20mA + I_{LOAD(MIN)}]}$$

Choosing a larger resistance minimizes the total power dissipation in the circuit by reducing the shunt current ($P_{D(TOTAL)} = V_S \times I_{SHUNT}$). Provide a safety margin to incorporate the worst-case tolerance of the resistor

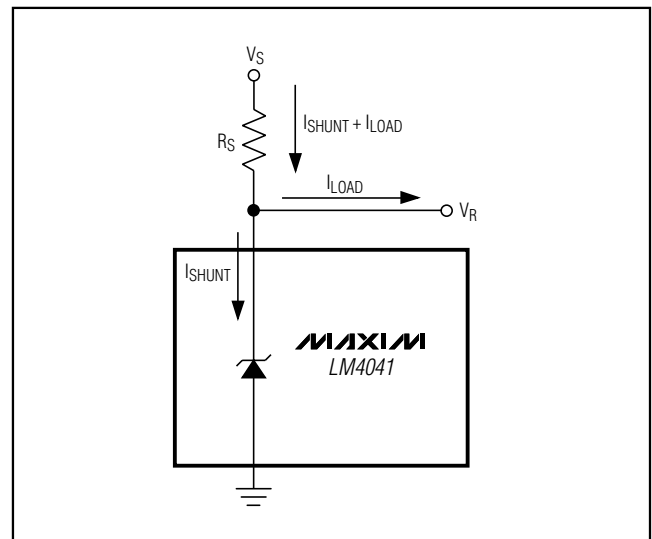


Figure 3. Typical Operating Circuit

used. Ensure that the resistor's power rating is adequate, using the following general power equation:

$$P_R = I_{SHUNT} \times (V_{S(MAX)} - V_R)$$

Output Capacitance

The LM4041 does not require an external capacitor for frequency stability and is stable for any output capacitance.

Temperature Performance

The LM4041 typically exhibits an output voltage temperature coefficient within $\pm 15\text{ppm}/^\circ\text{C}$. The polarity of the temperature coefficient may be different from one device to another; some may have positive coefficients, and others may have negative coefficients.

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High Temperature Operation

The maximum junction temperature of the LM4041 is +150°C. The maximum operating temperature for the LM4041_E_ is +125°C. At a maximum load current of 15mA and a maximum output voltage of 5V, the part will dissipate 75mW of power. The power dissipation limits of the 3-pin SC70 call for a derating value of 2.17mW/°C above +70°C and thus for 75mW of power dissipation, the part will selfheat to 35.56°C above ambient temperature. If the ambient temperature is

+125°C, the part operates at 159.56°C, thereby exceeding the maximum junction temperature value of +150°C. For high-temperature operation, care must be taken to ensure the combination of ambient temperature, output power dissipation, and package thermal resistance does not conspire to raise the device temperature beyond that listed in the *Absolute Maximum Ratings*. Either reduce the output load current or the ambient temperature to keep the part within the limits.

Chip Information

TRANSISTOR COUNT: 60
PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
3 SC70-3	X3-2	21-0075
3 SOT23-3	U3-1	21-0051

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
5	1/09	Changed part numbers to indicate lead-free	1

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